

General Description

The MAX9400/MAX9402/MAX9403/MAX9405 are extremely fast, low-skew quad LVECL/ECL or LVPECL/ PECL buffer/receivers designed for high-speed data and clock driver applications. These devices feature an ultra-low propagation delay of 335ps and channel-tochannel skew of 16ps in asynchronous mode with 86mA supply current.

The four channels can be operated synchronously with an external clock, or in asynchronous mode determined by the state of the SEL input. An enable input provides the ability to force all the outputs to a differential low state.

A variety of input and output terminations are offered for maximum design flexibility. The MAX9400 has open inputs and open emitter outputs. The MAX9402 has open inputs and 50Ω series outputs. The MAX9403 has 100Ω differential input impedance and open emitter outputs. The MAX9405 has 100Ω differential input impedance and 50Ω series outputs.

These devices operate with a supply voltage of (VCC -VEE) = 2.375V to 5.5V, and are specified for operation from -40°C to +85°C. These devices are offered in space-saving 32-pin 5mm × 5mm TQFP and 32-lead 5mm × 5mm QFN packages.

Applications

Data and Clock Driver and Buffer Central Office Backplane Clock Distribution **DSLAM** Backplane Base Station **ATF**

Functional Diagram appears at end of data sheet.

Features

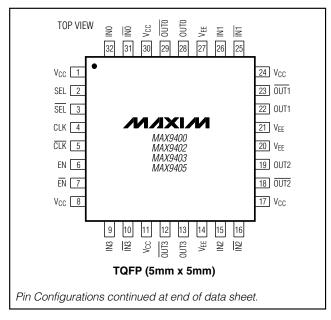
- ♦ 400mV Differential Output at 3.0GHz Data Rate
- ♦ 335ps Propagation Delay in Asynchronous Mode
- ♦ 8ps Channel-to-Channel Skew in Synchronous Mode
- ♦ Integrated 50Ω Outputs (MAX9402/MAX9405)
- ♦ Integrated 100Ω Inputs (MAX9403/MAX9405)
- **♦** Synchronous/Asynchronous Operation

Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	DATA INPUT	ОИТРИТ
MAX9400EHJ	-40°C to +85°C	32 TQFP	Open	Open
MAX9400EGJ*	-40°C to +85°C	32 QFN	Open	Open
MAX9402EHJ	-40°C to +85°C	32 TQFP	Open	50Ω
MAX9402EGJ*	-40°C to +85°C	32 QFN	Open	50Ω
MAX9403EHJ	-40°C to +85°C	32 TQFP	100Ω	Open
MAX9403EGJ*	-40°C to +85°C	32 QFN	100Ω	Open
MAX9405EHJ	-40°C to +85°C	32 TQFP	100Ω	50Ω
MAX9405EGJ*	-40°C to +85°C	32 QFN	100Ω	50Ω

^{*}Future product—contact factory for availability.

Pin Configurations



MIXIM

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

V _{CC} to V _{EE}	-0.3V to +6V
Inputs to VEE0.3V to ($(V_{CC} + 0.3V)$
Differential Input Voltage	
Continuous Output Current	50mA
Surge Output Current	
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
32-Pin 5mm x 5mm TQFP	
(derate 9.5mW/°C above +70°C)	761mW
32-Lead 5mm x 5mm QFN	
(derate 21.3mW/°C above +70°C)	1.7W
Junction-to-Ambient Thermal Resistance in Still Air	
32-Pin 5mm x 5mm TQFP	+105°C/W
32-Lead 5mm x 5mm QFN	+47°C/W

Junction-to-Ambient Thermal Resistance with 500LFPM Airflow 32-Pin 5mm x 5mm TQFP	+73°C/W
Junction-to-Case Thermal Resistance	
32-Pin 5mm x 5mm TQFP	+25°C/W
32-Lead 5mm x 5mm QFN	+2°C/W
Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	
ESD Protection	
Human Body Model (Inputs and Outputs)	2kV
Soldering Temperature (10s)	
,	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

(V_{CC} - V_{EE} = 2.375V to 5.5V, MAX9400/MAX9403 outputs terminated with 50Ω ±1% to V_{CC} - 2.0V. Typical values are at V_{CC} - V_{EE} = 3.3V, V_{IHD} = V_{CC} - 0.9V, V_{ILD} = V_{CC} - 1.7V, T_A = +25°C, unless otherwise noted.) (Notes 1, 2, and 3)

PARAMETER	SYMBOL		CONDITIONS	MIN	TYP	MAX	UNITS	
INPUTS (IN_, $\overline{\text{IN}}$ _, CLK, $\overline{\text{CLK}}$, EN,	EN, SEL, S	EL)						
Differential Input High Voltage	VIHD	Figure 1		V _{EE} + 1.4		Vcc	V	
Differential Input Low Voltage	V _{ILD}	Figure 1		VEE		V _{CC} - 0.2	V	
Differential Input Voltage	V _{ID}	Figure 1	V _{CC} - V _{EE} < +3.0V	0.2		V _{CC} -	V	
			V _{CC} - V _{EE} ≥ +3.0V	0.2		3.0		
land the Course	lee lee	MAX9400/ MAX9402	EN, $\overline{\text{EN}}$, SEL, $\overline{\text{SEL}}$, IN_, $\overline{\text{IN}}$, CLK, or $\overline{\text{CLK}}$ = V _{IHD} or V _{ILD}	-10		25		
Input Current	I _{IH} , I _{IL}	MAX9403/ MAX9405	EN, EN, SEL, SEL, CLK, or CLK = V _{IHD} or V _{ILD}	-10		25	μΑ	
Differential Input Resistance	R _{IN}	MAX9403/MAX	X9405	86		114	Ω	
OUTPUTS (OUT_, OUT_)								
Differential Output Voltage	V _{OH} -	Figure 1	Figure 1		660		mV	
Output Common-Mode Voltage	Vocm	Figure 1	Figure 1		V _{CC} - 1.25	V _{CC} -	V	
Internal Current Source	ISINK	MAX9402/MAX	X9405, Figure 2	6.5	8.3	10	mA	
Output Impedance	Rout	MAX9402/MAX	40	50	60	Ω		
POWER SUPPLY								
Supply Current	lee	MAX9402/MAX		150	180	mA		
Зарріў Сапені	'EE	MAX9400/MAX	MAX9400/MAX9403			118	IIIA	

AC ELECTRICAL CHARACTERISTICS

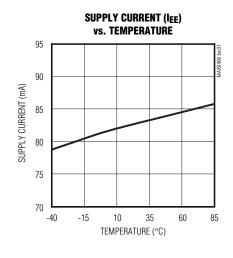
 $(V_{CC} - V_{EE} = 2.375 V \text{ to } 5.5 V$, outputs terminated with $50\Omega \pm 1\%$ to $V_{CC} - 2.0 V$, enabled, CLK = 3.2 GHz, $f_{IN} = 1.6 \text{GHz}$, input transition time = 125 ps (20% to 80%), $V_{IHD} = V_{EE} + 1.2 V$ to V_{CC} , $V_{ILD} = V_{EE}$ to $V_{CC} - 0.2 V$, $V_{IHD} - V_{ILD} = 0.2 V$ to smaller of $IV_{CC} - V_{EE} = 3.3 V$, $IV_{IHD} = V_{CC} - 0.9 V$, $IV_{ILD} = V_{CC} = 1.7 V$, $IV_{CC} = 1.7 V$,

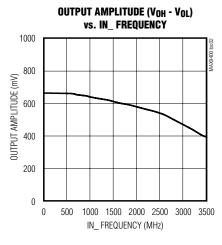
PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS	
IN-to-OUT Differential	t _{PLH1}	MAX9400/MAX9403	SEL = high, Figure 3	237	335	437	no	
Propagation Delay	tPHL1	MAX9402/MAX9405	SEL = High, Figure 3	237	335	437	ps	
CLK-to-OUT Differential	tPLH2	MAX9400/MAX9403	SEL = low, Figure 4	397	475	597	200	
Propagation Delay	tPHL2	MAX9402/MAX9405	SEL = IOW, Figure 4	397	475	597	ps	
IN-to-OUT Channel-to-Channel Skew (Note 5)	^t SKD1	SEL = high		16	80	ps		
CLK-to-OUT Channel-to- Channel Skew (Note 5)	tskD2	SEL = low		8	55	ps		
Maximum Clock Frequency	fCLK(MAX)	V _{OH} -V _{OL} ≥ 500mV, S	3.0			GHz		
Maximum Data Frequency	fIN(MAX)	$V_{OH} - V_{OL} \ge 400 \text{mV}, S$	2			GHZ		
Added Random Jitter (Note 6)	to.	SEL = low, $f_{CLK} = 3.0$		0.64	1.3	De/DMAON		
Added Natidom Sitter (Note 6)	t _{RJ}	SEL = high, f _{IN} = 2GH	lz		0.74	1.5	ps(RMS)	
Added Deterministic Jitter	4	SEL = low, $f_{CLK} = 3.0^{\circ}$ 2^{23} - 1 PRBS pattern		17	30			
(Note 6)	tDJ	SEL = high, IN = 2.0G pattern	ibps 2 ²³ - 1 PRBS		40	55	ps _(P-P)	
IN-to-CLK Setup Time	ts	Figure 4		80			ps	
CLK-to-IN Hold Time	tH	Figure 4		80			ps	
Output Rise Time	t _R	Figure 3			80	120	ps	
Output Fall Time	tF	Figure 3		80	120	ps		
Propagation Delay Temperature Coefficient	Δt _{PD} / ΔT				0.2	1	ps/°C	

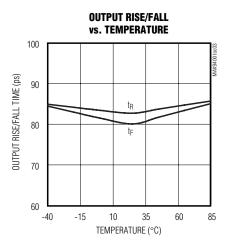
- Note 1: Measurements are made with the device in thermal equilibrium.
- Note 2: Current into a pin is defined as positive. Current out of a pin is defined as negative.
- Note 3: DC parameters are production tested at +25°C. DC limits are guaranteed by design and characterization over the full operating temperature range.
- Note 4: Guaranteed by design and characterization. Limits are set to ±6 sigma.
- Note 5: Measured between outputs of the same part at the signal crossing points for a same-edge transition.
- Note 6: Device jitter added to the input signal.

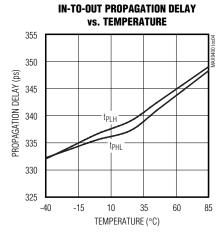
Typical Operating Characteristics

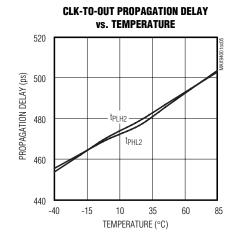
 $(V_{CC} - V_{EE} = 3.3V, MAX9400, outputs terminated with 50\Omega \pm 1\% to V_{CC} - 2.0V, enabled, SEL = high, CLK = 2.0GHz, f_{IN} = 1.0GHz, input transition time = 125ps (20% to 80%), V_{IHD} = V_{CC} - 1.0V, V_{ILD} = V_{CC} - 1.5V, T_{A} = +25^{\circ}C, unless otherwise noted.)$











Pin Description

PIN	NAME	FUNCTION
1, 8,11, 17, 24, 30	V _C C	Positive Supply Voltage. Bypass V _{CC} to V _{EE} with 0.1µF and 0.01µF ceramic capacitors. Place the capacitors as close to the device as possible with the smaller value capacitor closest to the device.
2	SEL	Noninverting Differential Select Input. Setting SEL = high and $\overline{\text{SEL}}$ = low (differential high) enables all four channels to operate asynchronously. Setting SEL = low and $\overline{\text{SEL}}$ = high (differential low) enables all four channels to operate in synchronous mode.
3	SEL	Inverting Differential Select Input
4	CLK	Noninverting Differential Clock Input
5	CLK	Inverting Differential Clock Input. A rising edge on CLK (and falling on $\overline{\text{CLK}}$) transfers data from the inputs to the outputs when SEL = low.
6	EN	Noninverting Differential Output Enable Input. Setting EN = high and $\overline{\rm EN}$ = low (differential high) enables the outputs. Setting EN = low and $\overline{\rm EN}$ = high (differential low) drives outputs low.
7	ĒN	Inverting Differential Output Enable Input
9	IN3	Noninverting Differential Input 3
10	ĪN3	Inverting Differential Input 3
12	OUT3	Inverting Differential Output 3
13	OUT3	Noninverting Differential Output 3
14, 20, 21, 27	V _{EE}	Negative Supply Voltage
15	IN2	Noninverting Differential Input 2
16	ĪN2	Inverting Differential Input 2
18	OUT2	Inverting Differential Output 2
19	OUT2	Noninverting Differential Output 2
22	OUT1	Noninverting Differential Output 1
23	OUT1	Inverting Differential Output 1
25	ĪN1	Inverting Differential Input 1
26	IN1	Noninverting Differential Input 1
28	OUT0	Noninverting Differential Output 0
29	OUT0	Inverting Differential Output 0
31	ĪNO	Inverting Differential Input 0
32	IN0	Noninverting Differential Input 0
_	EP	Exposed Paddle (MAX940_EGJ only). Connected to V _{EE} internally. See package dimensions.

Detailed Description

The MAX9400/MAX9402/MAX9403/MAX9405 are extremely fast, low-skew quad LVECL/ECL or LVPECL/PECL buffer/receivers designed for high-speed data and clock driver applications. The devices feature an ultra-low propagation delay of 335ps and channel-to-channel skew of 16ps in asynchronous mode with an 86mA supply current.

The four channels can be operated synchronously with an external clock, or in asynchronous mode, determined by the state of the SEL input. An enable input provides the ability to force all the outputs to a differential low state.

A variety of input and output terminations are offered for maximum design flexibility. The MAX9400 has open inputs and open-emitter outputs. The MAX9402 has open inputs and 50Ω series outputs. The MAX9403 has 100Ω differential input impedance and open-emitter outputs. The MAX9405 has 100Ω differential input impedance and 50Ω series outputs.

Supply Voltage

The MAX9400/MAX9402/MAX9403/MAX9405 are designed for operation with a single supply. Using a single negative supply of $V_{\rm EE}$ = -2.375V to -5.5V ($V_{\rm CC}$ = ground) yields LVECL/ECL-compatible input and output levels. Using a single positive supply of $V_{\rm CC}$ = 2.375V to 5.5V ($V_{\rm EE}$ = ground) yields LVPECL/PECL input and output levels.

Data Inputs

The MAX9400/MAX9402 have open inputs and require external termination. The MAX9403/MAX9405 have integrated 100 Ω differential input termination resistors from IN_ to $\overline{\text{IN}}$, reducing external component count.

Outputs

The MAX9402/MAX9405 have internal 50Ω series output termination resistors and 8mA internal pulldown current sources. Using integrated resistors reduces external component count.

The MAX9400/MAX9403 have open-emitter outputs. An external termination is required. See the *Output Termination* section.

Enable

Setting EN = high and $\overline{\text{EN}}$ = low enables the device. Setting EN = low and $\overline{\text{EN}}$ = high forces the outputs to a differential low, and all changes on CLK, SEL, and IN_ are ignored.

Asynchronous Operation

Setting SEL = high and SEL = low enables the four channels to operate independently as buffer/receivers.

The CLK signal is ignored in this mode. In asynchronous mode, the CLK signal should be set to either a logic low or high state to minimize noise coupling.

Synchronous Operation

Setting SEL = low and $\overline{\text{SEL}}$ = high enables all four channels to operate in synchronous mode. In this mode, buffered inputs are clocked into flip-flops simultaneously on the rising edge of the differential clock input (CLK and $\overline{\text{CLK}}$).

Differential Signal Input Limit

The maximum signal magnitude of the differential inputs is VCC - VEE or 3V, whichever is less.

Applications Information

Input Bias

Unused inputs should be biased or driven as shown in Figure 5. This avoids noise coupling that might cause toggling at the unused outputs.

Output Termination

Terminate open-emitter outputs (MAX9400/MAX9403) through 50Ω to V_{CC} - 2V or use an equivalent Thevenin termination. Terminate both outputs and use identical termination on each for the lowest output-to-output skew. When a single-ended signal is taken from a differential output, terminate both outputs. For example, if OUT_ is used as a single-ended output, terminate both OUT_ and \overline{OUT}_- .

Ensure that the output currents do not exceed the current limits as specified in the *Absolute Maximum Ratings* table. Under all operating conditions, the device's total thermal limits should be observed.

Power-Supply Bypassing

Adequate power-supply bypassing is necessary to maximize the performance and noise immunity. Bypass V_{CC} to V_{EE} with high-frequency surface-mount ceramic 0.1µF and 0.01µF capacitors as close to the device as possible with the 0.01µF capacitor closest to the device pins. Use multiple bypass vias for connection to minimize inductance.

Circuit Board Traces

Input and output trace characteristics affect the performance of the MAX9400/MAX9402/MAX9403/MAX9405. Connect each of the inputs and outputs to a 50Ω characteristic impedance trace. Avoid discontinuities in differential impedance and maximize common-mode noise immunity by maintaining the distance between differential traces and avoid sharp corners. Minimize the number of vias to prevent impedance discontinuities. Reduce reflections by maintaining the 50Ω char

acteristic impedance through connectors and across cables. Minimize skew by matching the electrical length of the traces.

Chip Information

TRANSISTOR COUNT: 713
PROCESS: Bipolar

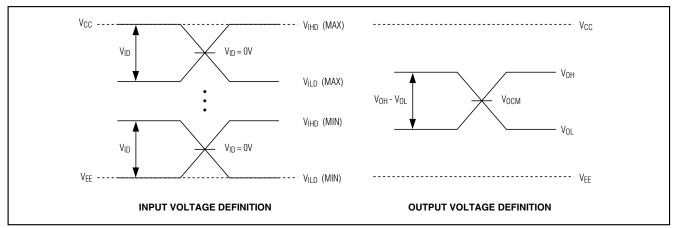


Figure 1. Input and Output Voltage Definitions

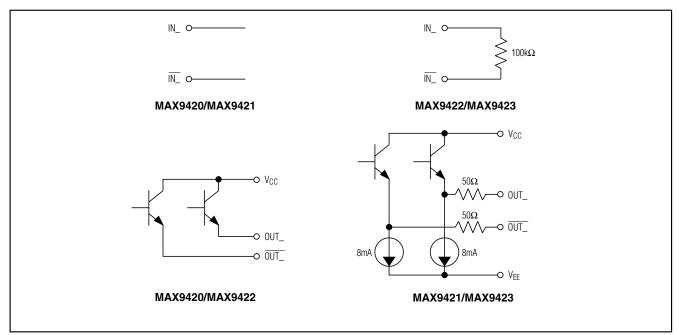


Figure 2. Input and Output Configurations

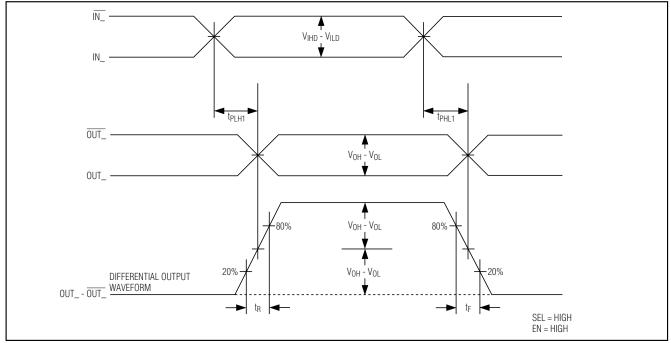


Figure 3. IN-to-OUT Propagation Delay and Transition Timing Diagram

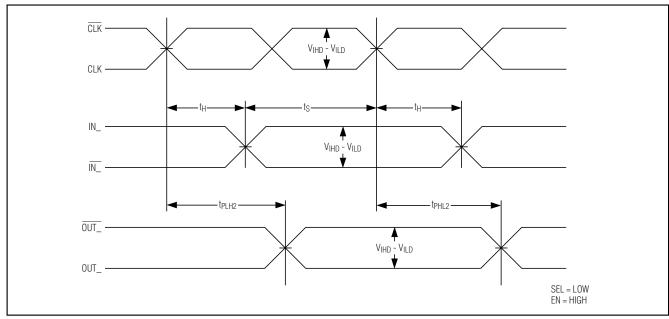


Figure 4. CLK-to-OUT Propagation Delay Timing Diagram

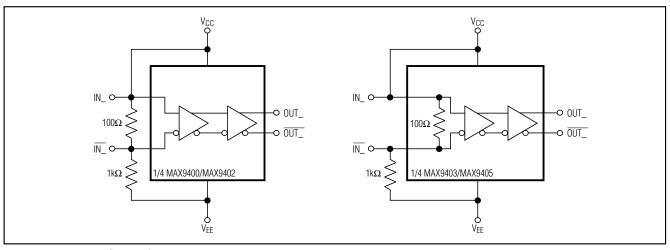
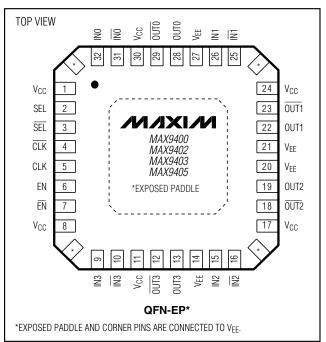
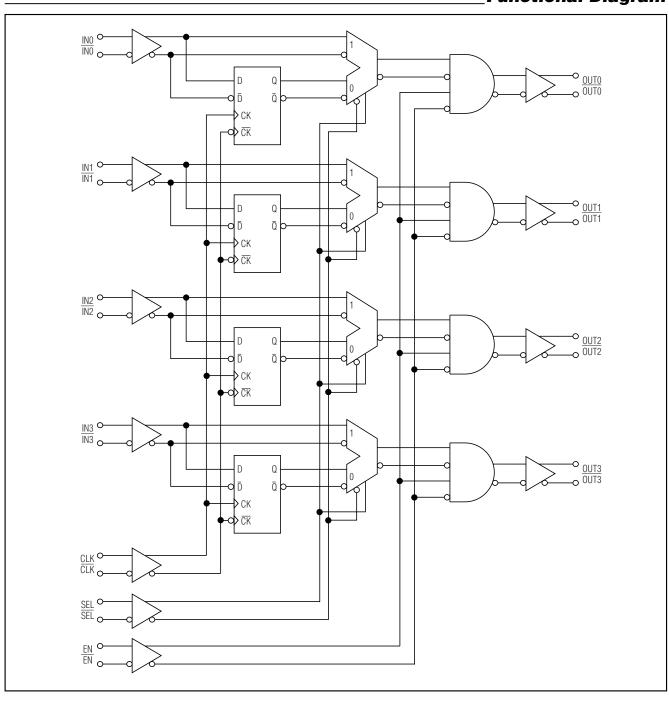


Figure 5. Input Bias Circuits for Unused Inputs

Pin Configurations (continued)

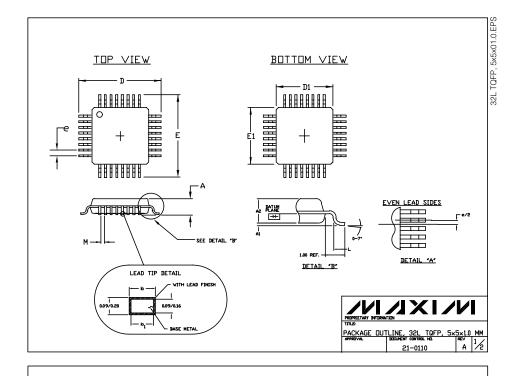


Functional Diagram



10 ______ M/XI/N

Package Information



- NOTES:

 1. ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5-1982.

 2. DATUM PLANE EHE IS LOCATED AT MOLD PARTING LINE AND COINCIDENT WITH LEAD, WHERE LEAD EXITS PLASTIC BODY AT BOTTOM OF PARTING LINE.

 3. DIMENSIONS DI AND EL DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON DI AND EL DIMENSIONS.

 4. THE TOP OF PACKAGE IS SMALLER THAN THE BOTTOM OF PACKAGE BY OLS MILLIMETERS.

 5. DIMENSION DE DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 MM TOTAL IN EXCESS OF THE DIMENSION AT MAXIMUM MATERIAL CONDITION.

 7. THIS OUTLINE DIMENSION HALL BE THE CONDITION.

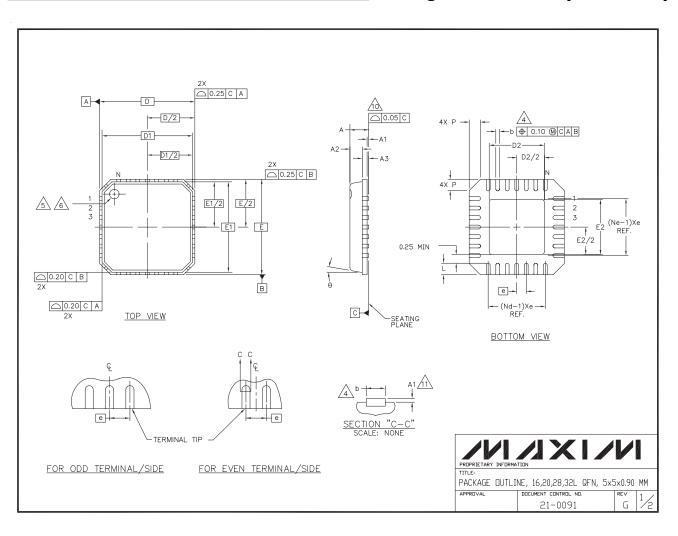
 8. THIS OUTLINE CONFORMS TO JEDEC PUBLICATION 95, REGISTRATION MG-196.

- MD-136. 8. LEADS SHALL BE COPLANAR WITHIN .004 INCH.

	JEDEC \	/ARIATIONS							
	DIMENSIONS IN MILLIMETERS								
	A	4							
	5×5×1	.0 MM 0.							
	MIN.	MAX.							
Α	74	1.20							
A ₁	0.05	0.15							
Az	0.95	1.05							
D	7.00 BSC.								
D_1	5.00 BSC.								
Ε	7.00 BSC.								
E1	5.00	BSC.							
L	0.45	0.75							
М	0.15	₹.							
N	3	2							
e	0.50 BSC.								
ю	0.17	0.27							
b1	0.17	0.23							



Package Information (continued)



MAX9400/MAX9402/MAX9403/MAX9405

Quad Differential LVECL/LVPECL Buffer/Receivers

Package Information (continued)

NOTES:

- 1. DIE THICKNESS ALLOWABLE IS 0.305mm MAXIMUM (.012 INCHES MAXIMUM)
- 2. DIMENSIONING & TOLERANCES CONFORM TO ASME Y14.5M. 1994.
- N IS THE NUMBER OF TERMINALS.

 Nd IS THE NUMBER OF TERMINALS IN X-DIRECTION &
 Ne IS THE NUMBER OF TERMINALS IN Y-DIRECTION.
- DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.20 AND 0.25mm FROM TERMINAL TIP.
- THE PIN #1 IDENTIFIER MUST BE EXISTED ON THE TOP SURFACE OF THE PACKAGE BY USING INDENTATION MARK OR INK/ LASER MARKED.
- 6. EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.
- 7. ALL DIMENSIONS ARE IN MILLIMETERS.
- 8. PACKAGE WARPAGE MAX 0.05mm.
- APPLIED FOR EXPOSED PAD AND TERMINALS.

 EXCLUDE EMBEDDED PART OF EXPOSED PAD FROM MEASURING.
- 10. MEETS JEDEC MO220.
- 11. THIS PACKAGE OUTLINE APPLIES TO ANVIL SINGULATION (STEPPED SIDES) AND TO SAW SINGULATION (STRAIGHT SIDES) QFN STYLES.

S								
SYMBOL	DIMENSIONS							
ို	MIN.	NOM.	MAX.	No _{TE}				
Α	0.80	0.90	1.00					
A1	0.00	0.01	0.05					
A2	0.00	0.65	1.00					
A3		0.20 REF.						
D								
D1		4.75 BSC						
Ε		5.00 BSC						
E1		4.75 BSC						
θ	0.	-	12°					
Р	0		0.60					
D2	1.25	_	3.25					
E2	1.25	-	3.25					

Y.	PITCH	VARIAT	ION B		1°. I	PITCH	VARIAT	ION B		ř.	PITCH	I VARIAT	ION C		Ϋ́,	PITCH	VARIAT	ION D	
Book	MIN.	NOM.	MAX.	NOT,	B	MIN	NOM.	MAX.	NOT_	B	MIN.	I NOM. I	MAX.	NOT_	B	MIN.	NOM.	MAX.	NO _{TE}
e	IVIII V.	0.80 BSC	1417 171.		e	IVIII V.	0.65 BSC	1917 171.	_	e	141114.	0.50 BSC	1917 171.		e		0.50 BSC		
N		16		3	N		20		3	N		28		3	N		32		3
Nd		4		3	Nd		5		3	Nd		7		3	Nd		8		3
Ne		4		3	Ne		5		3	Ne		7		3	Ne		8		3
	0.35	0.55	0.75		L	0.35	0.55	0.75		П	0.35	0.55	0.75		L	0.30	0.40	0.50	
Ь	0.28	0.33	0.40	4	b	0.23	0.28	0.35	4	Ь	0.18	0.23	0.30	4	b	0.18	0.23	0.30	4



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